PFM Mode Step-Up DC/DC Converter With True Shutdown

FEATURES

- Adjustable Output Voltage up to 24V.
- 2.7V to 5.5V Input Range.
- Maximum 0.1μA Shutdown Current.
- Tiny Inductor and Capacitors are allowed.
- Space-Saving SOT-23-6 Package.

APPLICATIONS

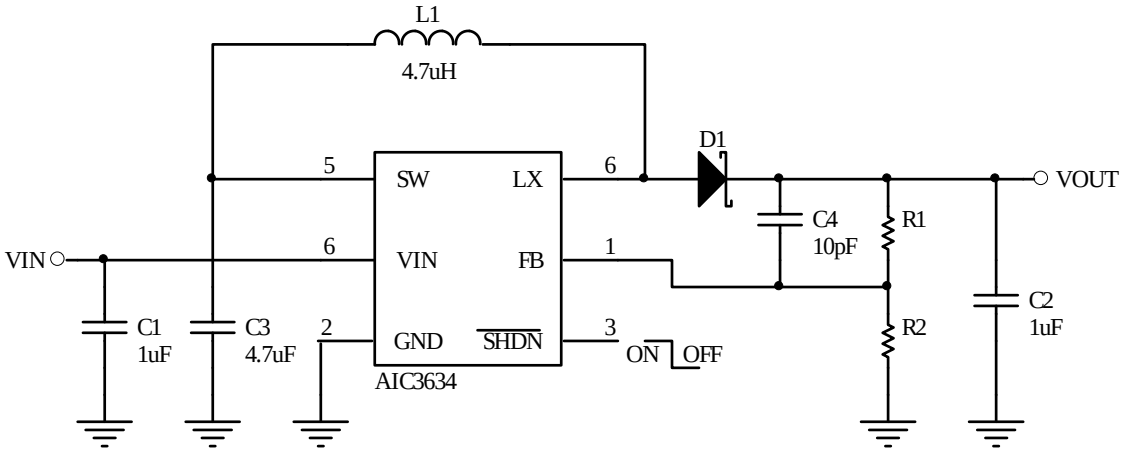
- LCD Bias
- LCM
- OLED Driver

DESCRIPTION

AIC3634 is a pulse-frequency modulation (PFM), step-up DC/DC Converter. The built-in high voltage N-channel MOSFET allows AIC3634 for step-up applications with up to 24V output voltage, as well as for Single Ended Primary Inductance Converter (SEPIC) and other low-side switching DC/DC converter.

The AIC3634 is available in a space-saving SOT-23-6 package.

TYPICAL APPLICATION CIRCUIT



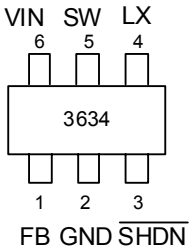
Typical Application Circuit

ORDERING INFORMATION

AIC3634 X XX XX

- PACKING TYPE
  TR: TAPE & REEL
  BG: BAG
- PACKAGE TYPE
  G6: SOT-23-6
- G: GREEN PACKAGE

Example: AIC3634GG6TR
→ in SOT-23-6 Green Package & Tape & Reel Packing Type

ORDER NUMBER	PIN CONFIGURATION
AIC3634GG6 (SOT-23-6)	FRONT VIEW  Note: Pin1 is determined by orienting the package marking as shown.

- **SOT-23-6 Marking**

Part No.	Marking
AIC3634GG6	3634G

ABSOLUTE MAXIMUM RATINGS

LX to GND 28V
FB to GND 6V
VIN, SW, $\overline{SHDN}$ 6V
SW Pin RMS Current 0.6A
Operating Ambient Temperature Range T_A ..... -40°C to 85°C
Operating Maximum Junction Temperature T_J ..... 125°C
Storage Temperature Range ..... -65°C to 150°C
Lead Temperature (Soldering 10 Sec.) ..... 260°C
Thermal Resistance Junction to Case SOT-23-6 ..... 115°C/W
Thermal Resistance Junction to Ambient SOT-23-6 ..... 250°C/W
(Assume no Ambient Airflow, no Heatsink)

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT

Refer to “TYPICAL APPLICATION CIRCUIT”.

ELECTRICAL CHARACTERISTICS

(V_{IN}=$V_{\overline{SHDN}}$=3.6V, SW=Open, T_A=25°C, unless otherwise specified) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Supply Range	V_{IN}		2.7		5.5	V
Output Voltage Adjust Range	V_{OUT}				24	V
V_{IN} Undervoltage Lockout	UVLO	V_{IN} rising, 50mV hysteresis	2.33	2.5	2.65	V
Quiescent Current	I_{IN}	V_{FB} = 1.3V, No switching		60	90	µA
Shutdown Supply Current		$V_{\overline{SHDN}}$ = 0V		0.01	0.5	µA
ERROR AMPLIFIER						
Feedback Voltage	V_{FB}	Note 1	1.202	1.226	1.250	V
FB Input Bias Current	I_{FB}	V_{FB} = 1.24V	-50		50	nA
Line Regulation		V_{CC} = 2.7V to 5.5V		0.1		%/V
Load Regulation		V_{OUT} = 15V, I_{LOAD} = 0 to 5mA		0.1		%/mA
OSCILLATOR						
Minimum LX Off-Time		V_{FB} > 1.1V		1		µS
		V_{FB} = 0.1V		5		
POWER SWITCH						
On-Resistance	$R_{DS(ON)}$	V_{IN} = 5V		0.9	1.5	Ω
Leakage Current	$I_{LX(OFF)}$	V_{LX} = 28V		0.1	2	µA
Switch Current Limit	I_{LX}		0.338	0.484	0.630	A
SOFT-START						
SW PMOS ON-Resistance		V_{IN} = 2.7V, I_{SW} = 100mA		1.5	2.5	Ω
SW PMOS Current Limit	I_{SW}	V_{IN} = 3.6V, V_{SW} = 0V	0.5	0.85	1.1	A
Delta Current limit	I_{SW} - I_{LX}		50			mA
SW PMOS Leakage Current		V_{IN} = 5.5V, V_{SW} = 0V			1	µA
SW PMOS Soft Start Time		V_{IN} = 2.7V, C_{SW} = 4.7uF		0.2	1	mS
CONTROL INPUT						
$\overline{SHDN}$ Input Low Voltage	V_{IL}				0.7	V
$\overline{SHDN}$ Input High Voltage	V_{IH}		1.5			V
$\overline{SHDN}$ Input Current	$I_{\overline{SHDN}}$	$V_{\overline{SHDN}}$ = 0V		0.01	0.1	µA

Note 1: Specifications are production tested at T_A=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

TYPICAL PERFORMANCE CHARACTERISTICS

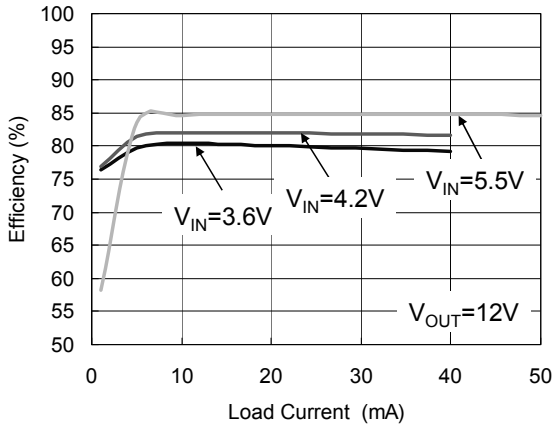


Fig. 1 Efficiency vs. Load Current

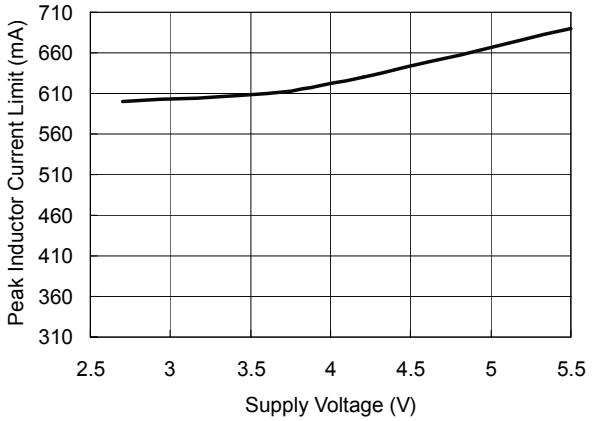


Fig. 2 Peak Inductor Current Limit vs. Supply Voltage

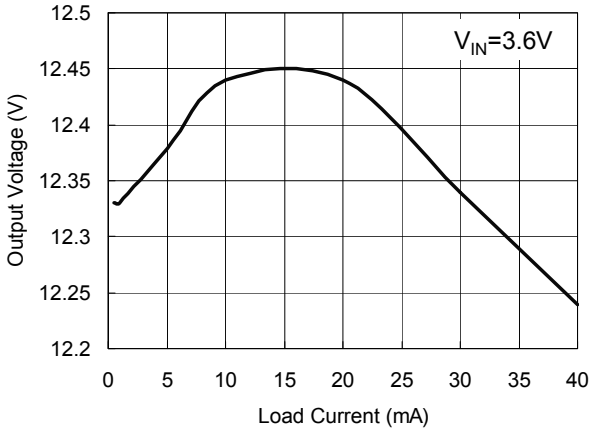


Fig. 3 Output Voltage vs. Load Current

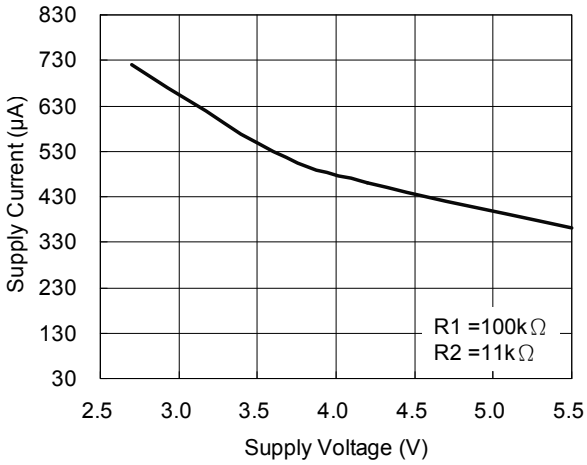


Fig. 4 Supply Current vs. Supply Voltage

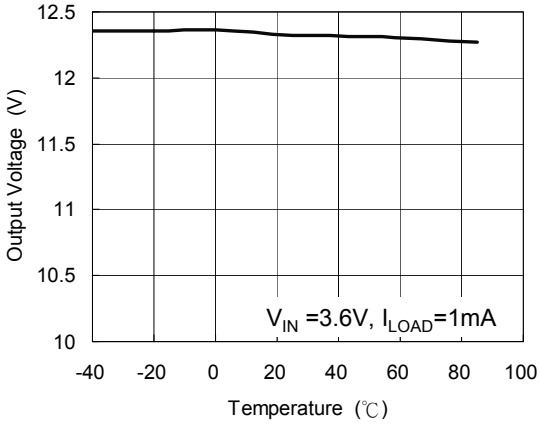


Fig. 5 Output Voltage vs. Temperature

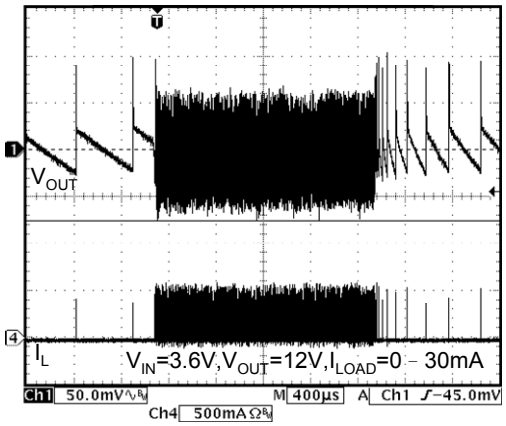


Fig. 6 Load Transient Response

TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

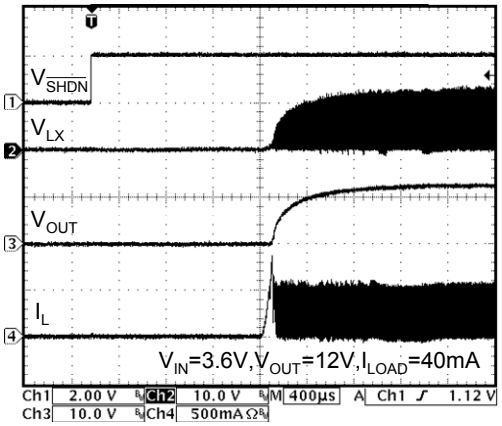


Fig. 7 Start Up Waveform

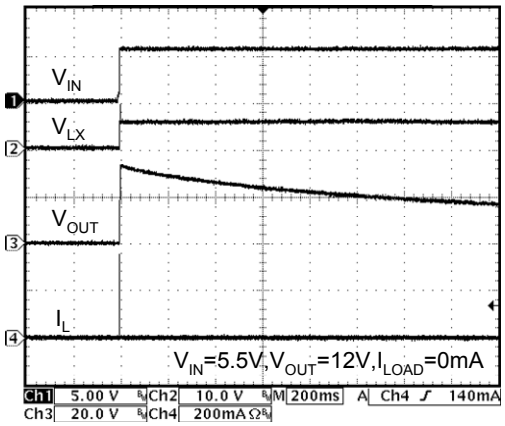


Fig. 8 Over Voltage Protection

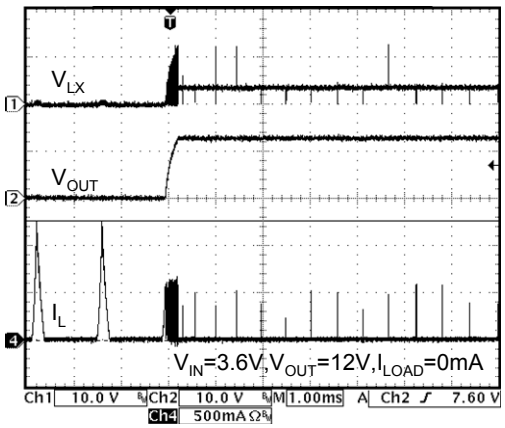


Fig. 9 Short Circuit Release

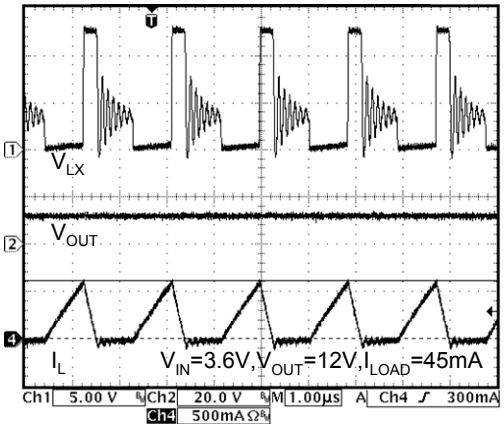
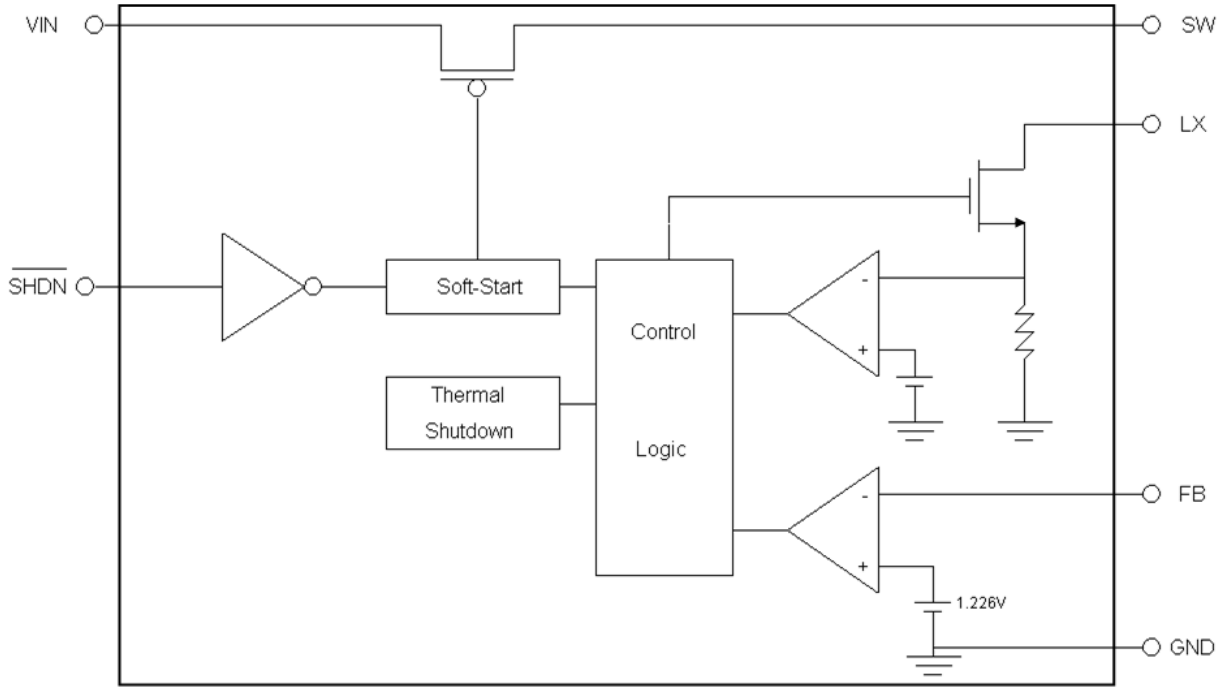


Fig. 10 Switching Waveform

BLOCK DIAGRAM



PIN DESCRIPTIONS

PIN 1: FB - Feedback Input. Connect a resistive voltage divider from the output to FB to set the output voltage.

PIN 2: GND - Ground.

PIN 3: $\overline{\text{SHDN}}$ - Shutdown Input. Drive $\overline{\text{SHDN}}$ low to turn off the converter. To automatically start the converter, connect $\overline{\text{SHDN}}$ to IN. Do not leave $\overline{\text{SHDN}}$ unconnected.

PIN 4: LX - Inductor Switching Connection.

PIN 5: SW - Power Switching Connection. Connect SW to inductor and output rectifier. Keep the distance between the components as close to SW as possible.

PIN 6: VIN - Internal Bias Voltage Input. Connect VIN pin to the input voltage source. Bypass VIN to GND with a capacitor sitting as close to VIN pin as possible.

APPLICATION INFORMATION

The AIC3634 is a step-up DC-DC converter. It is based on PFM controller topology. At the beginning of each switching cycle, the main switch (NMOS) is turned on and the inductor current starts to ramp. When the sensing current signal equals the main switch current limit value, the main switch is turned off and the inductor current flows through diode to supply the output. The AIC3634 has true-shutdown feature which has an internal P-channel MOSFET connecting from VIN pin to SW pin to protect main switch, diode and inductor during operation period. The AIC3634 can operate with an input voltage from 2.7V to 5.5V and adjustable output voltage up to 24V.

Device Shutdown

When $\overline{SHDN}$ pin is set logic high, the AIC3634 is put into active mode operation. If $\overline{SHDN}$ pin is set logic low, the device is put into shutdown mode and consumes less than 0.5μA of current. At the shutdown mode, the internal P-channel MOSFET will turn off and the output voltage of AIC3634 step-up converter will reduce to 0V.

Under-Voltage Lockout

Under-Voltage Lockout (UVLO) prevents the main switch from turning on until input voltage exceeds 2.5V typically. When the main switch turns on, if the input voltage drops below 2.4V typically, UVLO shuts off the main switch.

Adjustable Output Voltage

An external resistor divider is used to set the output voltage. The output voltage of the switching regulator (V_{OUT}) is determined by the following equation:

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R_1}{R_2}\right)$$

Where V_{FB} is 1.226V reference voltage.

Short Circuit Protection

While the output is shorted to ground, the surge current will flow through the internal P-channel MOSFET. If the surge current reaches the PMOS current limit, the internal P-channel MOSFET will turn off and restart soft-start. This would protect the inductor and diode from damage, and make sure downstream circuits are safe.

Soft-Start

The AIC3634 have soft-start function it can prevent large inrush current during start up period. During soft-start period, the internal P-channel MOSFET will turn on slowly.

Over Voltage Protection

If the feedback resistor is floating or other situation is happened to make the output voltage over normal voltage, the AIC3634 will stops switching, and the output voltage will reduce to VIN voltage.

Inductor Selection

A 2.2~4.7μH inductor is recommended for most AIC3634 applications. It is important to ensure the inductor saturation current value exceeds the peak value of inductor current in application to prevent core saturation.

Diode Selection

Schottky diodes, with their low forward voltage drop and fast reverse recovery, are the ideal choices for AIC3634 applications. The forward voltage drop of an Schottky diode represents the conduction losses in the diode, while the diode capacitance (CT or CD) represents the switching losses. For diode selection, both forward voltage drop and diode capacitance need to be considered. In addition, the rating of selected Schottky diode should be able to handle the output voltage and the maximum peak diode current.

Capacitor Selection

The small size of ceramic capacitors makes them ideal

for AIC3634 applications. When choosing the input and output ceramic capacitors, low ESR/ESL X5R and X7R types are recommended because they retain their capacitance over wider ranges of voltage and temperature than other types. A 1μF input capacitor and a 1μF output capacitor are sufficient for most applications. The SW pin is suggested to connect a 4.7μF or greater bypass capacitor. A 10pF feed-forward capacitor connected between output and FB pin is recommended, it can improve stability for most applications.

PCB Layout Guidance

This is a considerably high frequency for DC-DC converters. PCB layout is important to guarantee satisfactory performance. It is recommended to make traces of the power loop, especially where the switching node is involved, as short and wide as possible. First of all, the inductor, input and output capacitor should be as close to the device as possible. Feedback and shutdown circuits should avoid the proximity of large AC signals involving the power inductor and switching node.

APPLICATION EXAMPLE

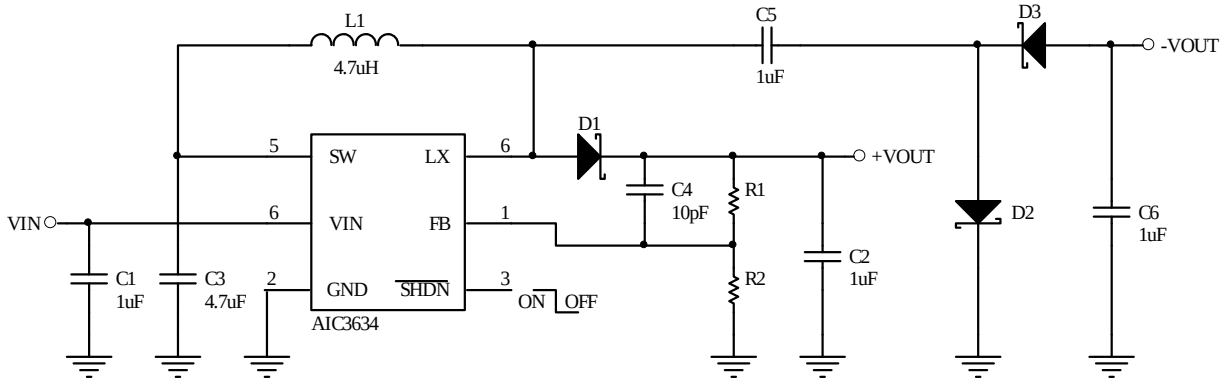
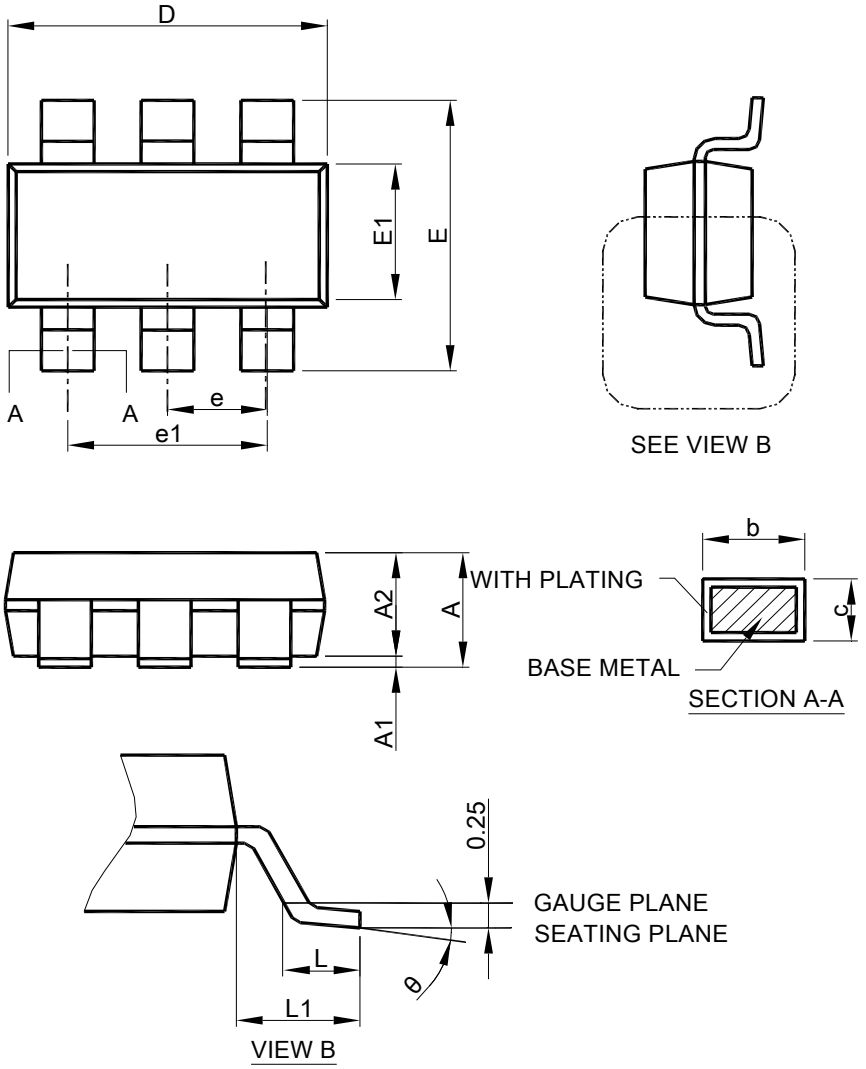


Fig. 11 Dual Output Application

PHYSICAL DIMENSIONS (unit: mm)

- **SOT-23-6**



SYMBOL	SOT-23-6	
	MILLIMETERS	
	MIN.	MAX.
A	0.95	1.45
A1	0.00	0.15
A2	0.90	1.30
b	0.30	0.50
c	0.08	0.22
D	2.80	3.00
E	2.60	3.00
E1	1.50	1.70
e	0.95 BSC	
e1	1.90 BSC	
L	0.30	0.60
L1	0.60 REF	
θ	0°	8°

Note : 1. Refer to JEDEC MO-178AB.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.
3. Dimension "E1" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Note: